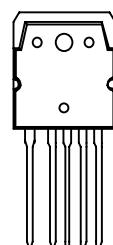


FEATURES

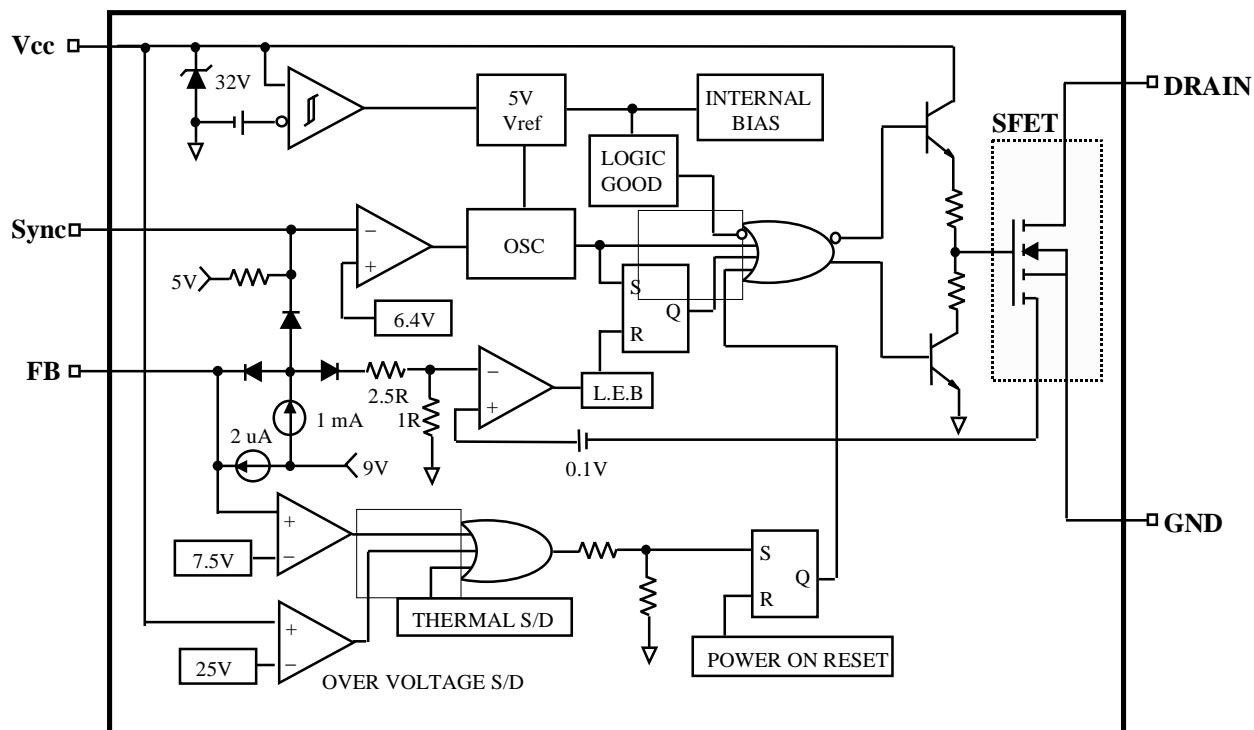
- Wide operating frequency range up to 150KHz
- Pulse by pulse over current limiting
- Over load protection
- Over voltage protection (min:23V)
- Internal thermal shutdown function
- Under voltage lockout
- Internal high voltage sense FET
- External sync terminal
- Latch Mode

PRODUCT SUMMARY

Part Number	BVDSS	Rds(on)	ID
KA2S1265	650V	0.72Ω	12A

TO-3P

1. DRAIN 2.GND 3.Vcc 4.FB 5. Sync

BLOCK DIAGRAM

ABSOLUTE MAXIMUM RATINGS

Characteristic	Symbol	Value	Unit
Drain - Source(GND) Voltage (1)	V _{DSS}	650	V
Drain - Gate Voltage ($R_{GS} = 1M\Omega$)	V _{DGR}	650	V
Gate - Source(GND) Voltage	V _{GS}	± 30	V
Drain Current Pulsed (2)	I _{DM}	48.0	A _{DC}
Single Pulsed Avalanche Energy (3)	E _{AS}	785	mJ
Avalanche Current	I _{AS}	-	A
Continuous Drain Current ($T_c = 25^\circ C$)	I _D	12	A _{DC}
Continuous Drain Current ($T_c = 100^\circ C$)	I _D	8.4	A _{DC}
Supply Voltage	V _{CC}	30	V
Analog Input Voltage Range	V _{FB}	-0.3 ~ V _{SD}	V
Total Power Dissipation	P _D (wt H/S)	269	W
	Derating	2.17	W/°C
Operating Temperature	T _{OPR}	- 25 ~ + 85	°C
Storage Temperature	T _{TSG}	- 55 ~ + 150	°C

Notes: (1) $T_j = 25^\circ C$ to $150^\circ C$

(2) Repetitive rating : Pulse width limited by maximum junction temperature

(3) $L = 10mH$, $V_{DD} = 50V$, $R_G = 27\Omega$, starting $T_j = 25^\circ C$

ELECTRICAL CHARACTERISTICS (SFET part)

($T_a = 25^\circ C$ unless otherwise specified)

Symbol	Characteristic	Min	Typ	Max	Units	Test Conditions
BV _{DSS}	Drain-Source Breakdown Voltage	650	-	-	V	V _{GS} =0V, I _D =50uA
I _{DSS}	Zero Gate Voltage Drain Current	-	-	50	uA	V _{DS} =Max, Rating, V _{GS} =0V
		-	-	200	uA	V _{DS} =0.8Max, Rating, V _{GS} =0V TC=125 °C
R _{D(on)}	Static Drain-Source On Resistance(4)	-	0.72	-	Ω	V _{GS} = 10V, I _D = 6.0A

ELECTRICAL CHARACTERISTICS (SFET part continued)

(Ta = 25°C unless otherwise specified)

Symbol	Characteristic	Min	Typ	Max	Units	Test Conditions
g _{fs}	Forward Transconductance(4)	5.7	-	-	mho	V _{DS} =50V, I _D =6.0A
C _{iss}	Input Capacitance	-	2700	-	pF	V _{GS} = 0V, V _{DS} = 25V, f = 1MHz
C _{oss}	Output Capacitance	-	300	-		
C _{rss}	Reverse Transfer Capacitance	-	61	-		
t _{d(on)}	Turn On Delay Time	-	18	-	nS	V _{DD} = 0.5BV _{DSS} , I _D = 12.0A (MOSFET switching time are essentiaiy independent of operating temperature)
t _r	Rise Time	-	37	-		
t _{d(off)}	Turn Off Delay Time	-	88	-		
t _f	Fall Time	-	36	-		
Q _g	Total Gate Charge (Gate-Source + Gate-Drain)	-	-	140	nC	V _{GS} = 10V, I _D = 12.0A V _{DS} = 0.5BV _{DSS} (MOSFET switching time are essentiaiy independent of operating temperature)
Q _{gs}	Gate-Source Charge	-	20	-		
Q _{gd}	Gate-Drain(Miller) Charge	-	69	-		

Notes: (1) T_J = 25°C to 150 °C

(2) Repetitive rating : Pulse width limited by maximum junction temperature

(3) L = 10mH, V_{DD} =50V, R_G = 27Ω, starting T_j = 25°C

(4) Pulse Test : Pulse width ≤ 300uS, Duty Cycle ≤ 2 %

ELECTRICAL CHARACTERISTICS (Control part)

(Ta = 25 °C unless otherwise specified)

Symbol	Characteristics	Min	Typ	Max	Unit	Test Conditions
REFERENCE SECTION						
Vref	Output Voltage (Note 1)	4.80	5.00	5.20	V	Ta = 25 °C
Vref/ ΔT	Temperature Stability (Note 1&2)	-	0.3	0.6	mV/°C	-25 °C ≤ Ta ≤ +85 °C
OSCILLATOR SECTION						
Fosc	Initial Accuracy	18	20	22	KHz	Ta = 25 °C
ΔF / ΔT	Frequency Change with Temperature (Note 2)		±5	±10	%	-25 °C ≤ Ta ≤ +85 °C
VSYTH	Sync Threshold Voltage	6.0	6.4	6.8	V	Vfb = 5 V
D _{MAX}	Maximum Duty Cycle	92	95	98	%	
FEEDBACK SECTION						
I _{FB}	Feedback Source Current	0.8	1	1.2	mA	Ta = 25 °C, Vfb = GND
I _{delay}	Shutdown Delay Current	1.4	1.8	2.2	uA	Ta = 25 °C, 5 V ≤ Vfb ≤ V _{SD}
OVER CURRENT PROTECTION SECTION						
I _{L(MAX)}	Over Current Protection	7.04	8.00	8.96	A	Max. Inductor Current
UVLO SECTION						
V _{th(H)}	Start Threshold Voltage	14	15	16	V	
V _{th(L)}	Minimum Operating Voltage	9	10	11	V	After turn on

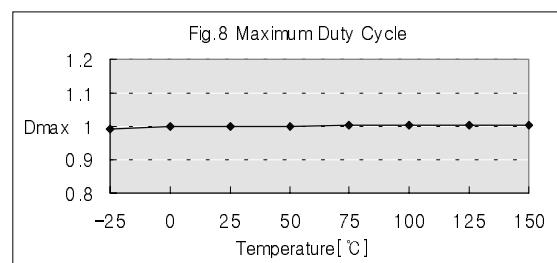
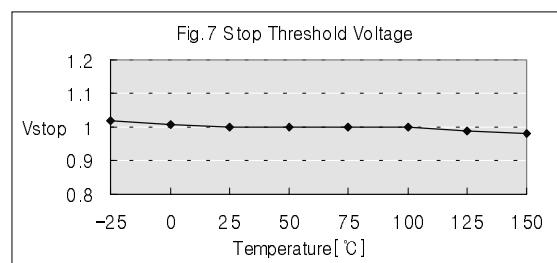
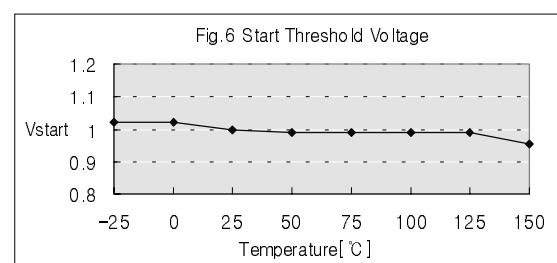
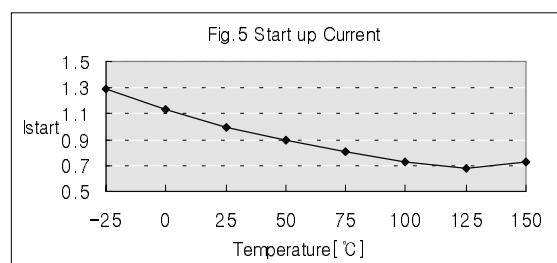
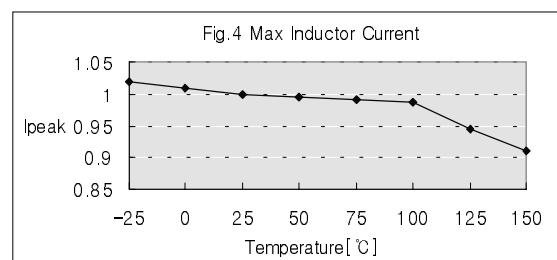
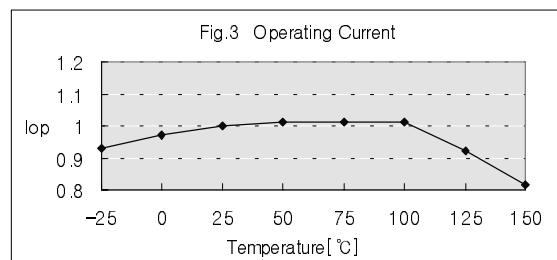
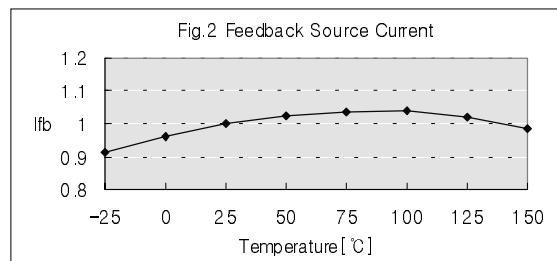
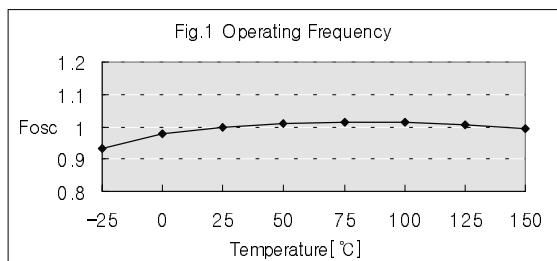
ELECTRICAL CHARACTERISTICS (Continued)

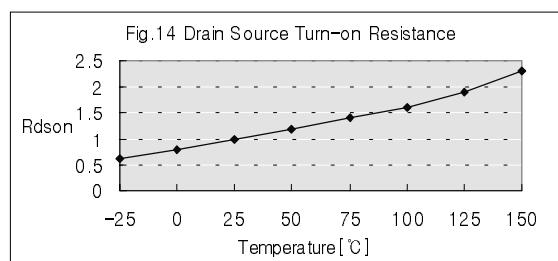
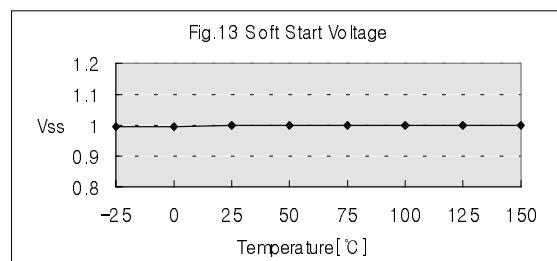
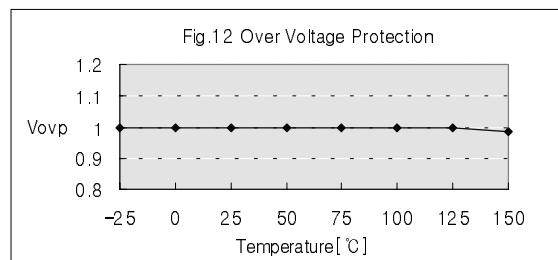
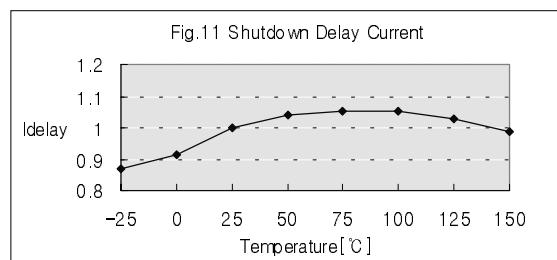
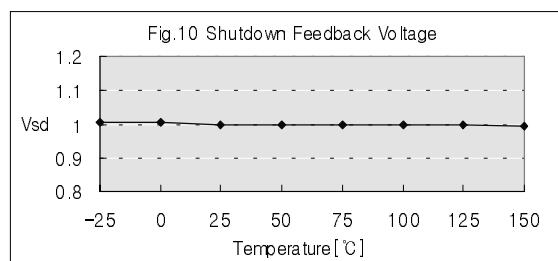
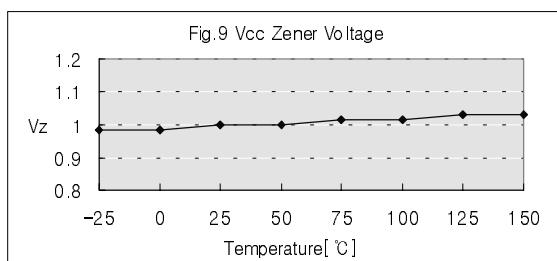
(Ta = 25 °C unless otherwise specified)

Symbol	Characteristics	Min	Typ	Max	Unit	Test Conditions
TOTAL STANDBY CURRENT SECTION						
I _{ST}	Start up Current	0.1	0.3	0.55	mA	V _{CC} = 14V
I _{OPR}	Operating Supply Current (control part only)	6	12	18	mA	T _a = 25 °C ,
V _Z	V _{CC} Zener Voltage	30	32.5	35	V	I _{CC} = 20mA
SHUTDOWN SECTION						
V _{SD}	Shutdown Feedback Voltage	6.9	7.5	8.1	V	
T _{SD}	Thermal Shutdown Temperature(T _j)	140	160	-	°C	(Note 1)
SOFT START SECTION						
I _{SS}	Soft Start Current	0.8	-	-	mA	Sync&S/S = GND
V _{SS}	Soft Start Voltage	4.7	5.0	5.4	V	V _{FB} = 2V

Notes: (1) These parameters, although guaranteed, are not 100% tested in production

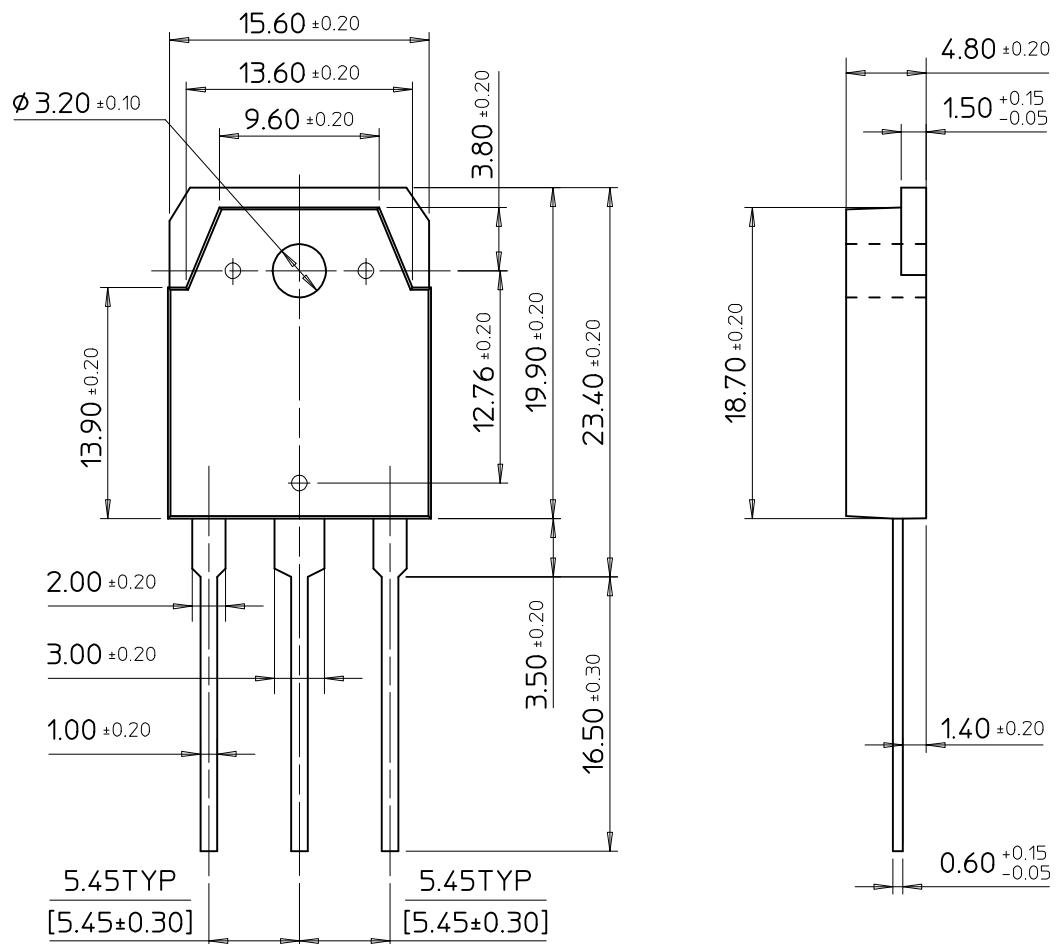
(2) These parameters, although guaranteed, are tested in EDS(wafer test) process.

TYPICAL PERFORMANCE CHARACTERISTICS

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

TO-3P

Dimensions in Millimeters



SAMSUNG ELECTRONICS CO.,LTD.